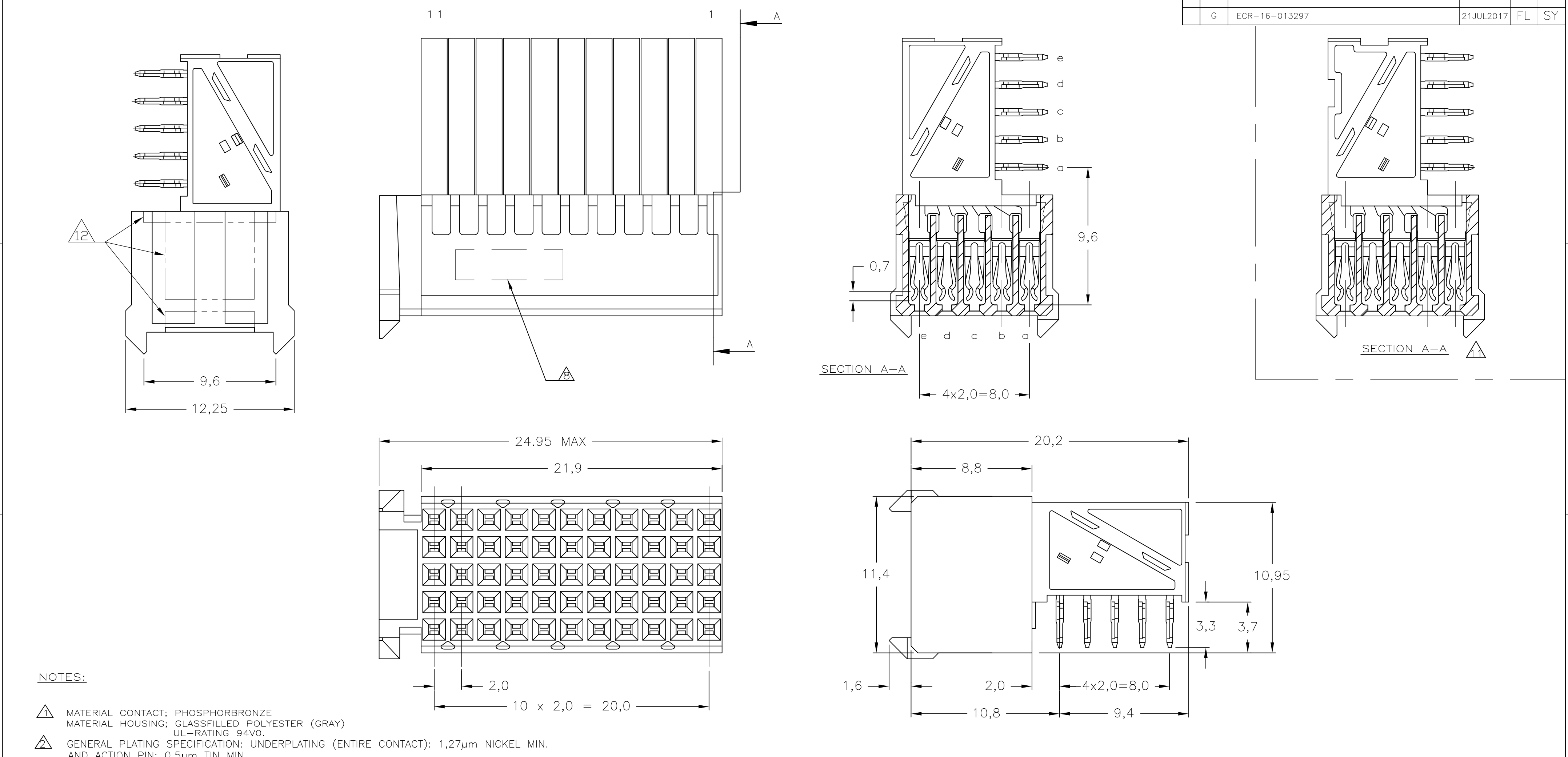
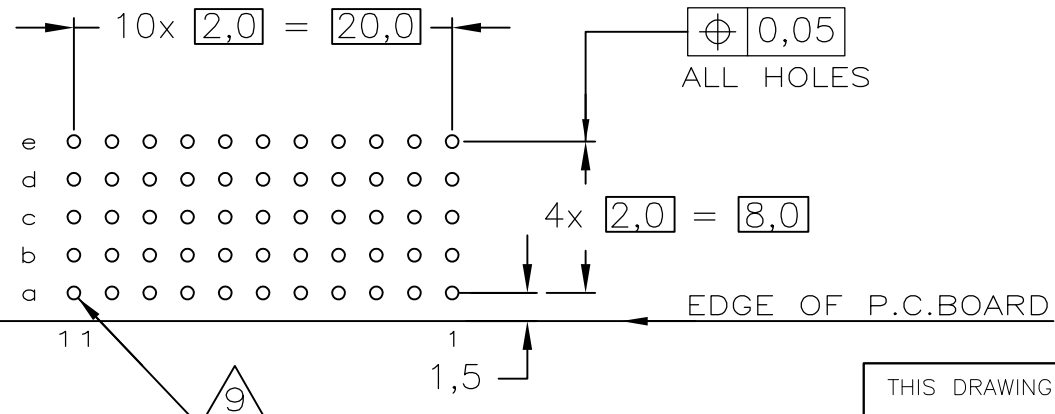




NOTES:

- 1 MATERIAL CONTACT; PHOSPHORBRONZE
MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
UL-RATING 94VO.
- 2 GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN.
AND ACTION PIN: 0,5µm TIN MIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 3 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- 4 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- 5 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- 6 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III, UNCONTROLLED ENVIRONMENT APPLICATIONS.
- 7 CONNECTOR LUBRICATED WITH TELCORDIA GR-1217-CORE APPROVED LUBRICANT.
- 8 CONNECTOR PRINTED WITH PARTNUMBER AND DATECODE
THE MARKING CAN APPEAR ON THE FRONT SIDE OR ON THE BACK SIDE.
- 9 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID. 55 HOLES
- 10 FITS WITH INTEGRATED GROUND RETURN UPPERSHIELD, BASIC P.N. 5352111
AND INTEGRATED GROUND RETURN LOWERSHIELD, BASIC P.N. 5352112
- 11 CONNECTOR ASSEMBLED WITH REDESIGNED CONTACTS.
CONTACTS HAVE A CORING-OUT IN THE PLASTIC.
- 12 ALTERNATE CORING-OUT IN HOUSING; NON-FUNCTIONAL.
- 13 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- 14 0.76µm MIN. GOLD PLATING AT MATING SURFACES.



SCALE 2,5:1

COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT

P.C.B. HOLE DIM. ACTION PIN
FOR DETAILS SEE
APPLICATION SPECIFICATION

	2314	1	3-5100161-0
OBSOLETE	267	1	1-5100161-9
	267	1	5100161-9
OBSOLETE	24	1	5100161-4
	23	1	5100161-1
FINISH		MATERIAL	PART NUMBER
K.N.KIRAN		TE Connectivity	
B.MOOIJ		Z-PACK 2mm HM TYPE C	
B.MOOIJ		55 POS. FEMALE CONNECTOR	
108-19082		SIZE	RESTRICTED TO
114-19029		CAGE CODE	
0.00000		DRAWING NO	
CUSTOMER DRAWING		00779	
		SCALE	REV
		4:1	G
		SHEET	
		1 of 1	